### TOSHIBA

**TPCF8103** 

TOSHIBA FIELD EFFECT TRANSISTOR SILICON P CHANNEL MOS TYPE(U - MOS

# TPCF8103

Tentative

NOTE BOOK PC APPLICATIONS

PORTABLE EQUIPMENTS APPLICATIONS

UNIT:mm

- Low Drain Source ON Resistance : R<sub>DS(ON)</sub> = 72m (Typ.)
- High Forward Transfer Admittance: | Y f s | = 6 S(Typ.)
- Low Leakage Current :  $I_{DSS} = -10 \,\mu$  A (Max.) ( $V_{DS} = -20 \,V$ )
- Enhancement Mode :  $V_{th} = -0.5 \sim -1.2 \text{ V} (V_{DS} = -10 \text{ V}, I_D = -200 \mu \text{ A})$

#### MAXIMUM RATINGS (Ta = 25)

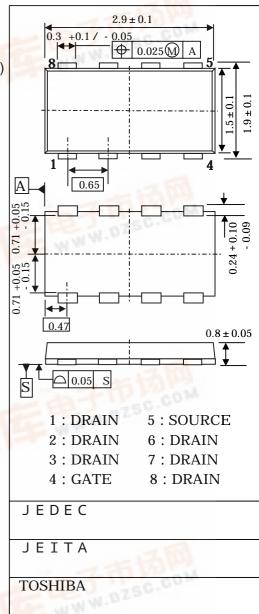
	- /						
CHARACTERI	STIC	SYMBOL	RATING	UNIT			
Drain - Source Volta	ge	V <sub>DSS</sub>	-20	V			
Drain - Gate Voltage	FISH W.	V <sub>DGR</sub>	-20	V			
$(R_{GS} = 20 k)$							
Gate - Source Voltag	е	$V_{GSS}$	± 8	V			
Drain Current	DC (Note1)	ΙD	-2.7	Α			
Diam current	Pulse (Note1)	Ι <sub>DP</sub>	-10.8	Α			
Drain Power Dissi	pation (t=5s)		2.5	W			
(Note2a)		17	1 100	W(P)			
Drain Power Dissi	pation (t=5s)	PD	0.7	W			
(Note2b)							
Single Pulse Avalanch	e E <mark>nergy</mark> (Note3)	E <sub>AS</sub>	1.2	m J			
Avalanc <mark>he Current</mark>	No. of Concession, Name of Street, or other party of the Concession, Name of Street, or other pa	IAR	-1.35	Α			
Repetitive Avalanche	Energy (Note4)	E <sub>AR</sub>	0.25	m J			
Channel Temperature		T <sub>c h</sub>	150				
Storage Temperature	Range	T <sub>stg</sub>	- 55 ~ 150				

#### THERMAL CHARACTERISTICS

CHARACTERISTICS	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to	R <sub>th(ch-a)</sub>	50.0	/ W
Ambient (t=5s) (Note2a)	N.B.L.		
Thermal Resistance, Channel to	R <sub>th(ch-a)</sub>	178.6	/ W
Ambient (t=5s) (Note2b)	(2.1. 2)		

Note1, Note2, Note3, Note4, Note5 Please see next page.

THIS TRANSISTOR IS AN ELECTROSTATIC SENSITIVE DEVICE.
PLEASE HANDLE WITH CAUTION.





## ELECTRICAL CHARACTERISTICS (Ta = 25)

Т	e	n	t	а	t	i	V	e	
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ELECTRICAL CHARACTERISTICS (Ta = 25)							
CHARACTERISTICS		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage	Current	I <sub>GSS</sub>	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	-	-	± 10	μΑ
Drain Cut-of	f Current	I <sub>DSS</sub>	$V_{DS} = -20V$ , $V_{GS} = 0V$	-	-	-10	μΑ
Drain-Source	Breakdown	$V_{(BR)DSS}$	$I_D = -10 \text{m A}$ , $V_{GS} = 0 \text{ V}$	-20	-	-	V
Voltage		$V_{(BR)DSX}$	$I_D = -10 \text{m A}$ , $V_{GS} = 8 \text{ V}$	-8	-	-	V
Gate Thresho	ld Voltage	$V_{th}$	$V_{DS} = -10 V$ , $I_D = -200 \mu A$	-0.5	-	-1.2	V
			$V_{GS} = -1.8V$ , $I_D = -1.4A$	-	215	300	m
Drain-Source	ON Resistance	$R_{DS(ON)}$	$V_{GS} = -2.5V$ , $I_D = -2.8A$	-	110	160	
			$V_{GS} = -4.5V$ , $I_D = -2.8A$	-	72	110	
Forward Tran	Forward Transfer Admittance		$V_{DS} = -10V$ , $I_{D} = -2.8A$	3.0	6.0	-	S
Input Capacitance		C <sub>iss</sub>	$V_{DS} = -10V$ , $V_{GS} = 0V$	-	470	-	рF
Reverse Tran	Reverse Transfer Capacitance		f = 1M H z	-	70	-	
Output Capacitance		C <sub>r s s</sub>		-	80	-	
	Rise Time	t <sub>r</sub>	$I_{p}=-1.4A$ VOUT $V_{gs}$ $R_{L}=7.14$	-	5	-	ns
Switching	Turn-on Time	t <sub>o n</sub>		-	9	ı	
Time	Fall Time	t <sub>f</sub>	-5V 4.7 \$	-	8	-	
	Turn-off Time	t off	Duty 1%, tw=10us	-	26	-	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q <sub>g</sub>	V <sub>DD</sub> -16V , V <sub>GS</sub> = -5V	-	6	-	2.0
Gate-Source Charge		$Q_{gs}$	I <sub>D</sub> = -2.7A	-	4.5	-	n C
Gate-Drain("Miller")Charge		$Q_{gd}$		-	1.5	-	

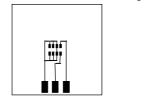
## SOURCE - DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Pulse Drain Reverse Current	$I_{DRP}$	-	-	-	-10.8	Α
(Note1)						
Diode Forward Voltage	V <sub>DSF</sub>	$I_{DR} = -2.7A$ , $V_{GS} = 0V$	ı	ı	1.2	V

Note1 Please use devices on condition that the channel temperature is below 150  $\,$  . Note2:

(a) Device mounted on glass-epoxy board (b) Device mounted on glass-epoxy board (b)

FR-4



(b)

FR-4  $25.4 \times 25.4 \times 0.8$  (Unit in mm)

(a)

 $25.4 \times 25.4 \times 0.8$  (Unit in mm)

Note3:  $V_{DD}$ =-16V, Tch=25 (initial), L=0.5mH, R<sub>G</sub>=25 , I<sub>AR</sub>=-1.35A

Note4: Repetitive rating ; Pulse Width Limited by Max. Channel Temperature.

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